

PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT						
NATURE OF CONVEYANCE:	ASSIGNMENT						
CONVEYING PARTY DATA							
<table border="1"> <thead> <tr> <th>Name</th> <th>Execution Date</th> </tr> </thead> <tbody> <tr> <td>CHAI MEI JIMMY YU</td> <td>10/22/2013</td> </tr> <tr> <td>FENG WANG</td> <td>10/22/2013</td> </tr> </tbody> </table>		Name	Execution Date	CHAI MEI JIMMY YU	10/22/2013	FENG WANG	10/22/2013
Name	Execution Date						
CHAI MEI JIMMY YU	10/22/2013						
FENG WANG	10/22/2013						
RECEIVING PARTY DATA							
Name:	THE CHINESE UNIVERSITY OF HONG KONG						
Street Address:	SHATIN, NEW TERRITORIES						
City:	HONG KONG						
State/Country:	CHINA						
PROPERTY NUMBERS Total: 1							
<table border="1"> <thead> <tr> <th>Property Type</th> <th>Number</th> </tr> </thead> <tbody> <tr> <td>Application Number:</td> <td>14023853</td> </tr> </tbody> </table>		Property Type	Number	Application Number:	14023853		
Property Type	Number						
Application Number:	14023853						
CORRESPONDENCE DATA							
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ATTORNEY DOCKET NUMBER:	200167.431						
NAME OF SUBMITTER:	HAI HAN, PH.D.						
Signature:	/Hai Han/						
Date:	10/28/2013						
Total Attachments: 2 source=200167_431_ASSIGNMENT#page1.tif source=200167_431_ASSIGNMENT#page2.tif							

OP \$40.00 14023853

ASSIGNMENT

WHEREAS, WE, **YU Chai Mei Jimmy** and **WANG Feng**, ASSIGNORS, citizens of United States and China, residing at Flat 3E, Block 8, The Paramount, Tai Po, New Territories, Hong Kong SAR and Flat 201, Block 3, Zhou Yuan West Road Number 67, Meng Cheng County, Anhui Province, People's Republic of China, respectively, are the inventors of the invention in

CoP2 Loaded Red Phosphorus, Preparation and Use of the Same

for which we have executed an application for a Patent of the United States

which is identified by Seed Intellectual Property Law Group PLLC docket no. 200167.431
which was filed on **11 September 2013**, Application No. **14/023,853**.

and WHEREAS, The Chinese University of Hong Kong, ASSIGNEE, located at Shatin, New Territories, Hong Kong SAR, CHINA is desirous of obtaining our entire right, title and interest in, to and under the said invention and the said application:

NOW, THEREFORE, in consideration of the sum of One Dollar (\$1.00) to us in hand paid, and other good and valuable consideration, the receipt and sufficiency of which is hereby acknowledged, WE, the said ASSIGNORS, have sold, assigned, transferred and set over, and by these presents do hereby sell, assign, transfer and set over, unto the said ASSIGNEE, its successors, legal representatives and assigns, our entire right, title and interest in, to and under the said invention, and the said United States application and all divisions, renewals and continuations thereof, and all Patents of the United States which may be granted thereon and all reissues and extensions thereof; and all applications for industrial property protection, including, without limitation, all applications for patents, utility models, and designs which may hereafter be filed for said invention in any country or countries foreign to the United States, together with the right to file such applications and the right to claim for the same the priority rights derived from said United States application under the Patent Laws of the United States, the International Convention for the Protection of Industrial Property, or any other international agreement or the domestic laws of the country in which any such application is filed, as may be applicable; and all forms of industrial property protection, including without limitation, patents, utility models, inventors' certificates and designs which may be granted for said invention in any country or countries foreign to the United States and all extensions, renewal and reissues thereof;

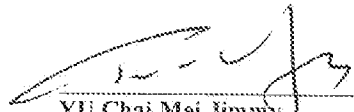
AND WE HEREBY authorize and request the Commissioner of Patents, and any Official of any country or countries foreign to the United States, whose duty it is to issue patents or other evidence or forms of industrial property protection on applications as aforesaid, to issue the same to the said ASSIGNEE, its successors, legal representatives and assigns, in accordance with the terms of this instrument.

AND WE HEREBY covenant and agree that we have full right to convey the entire rights, title and interest herein assigned, and that we have not executed, and will not execute, any agreement in conflict herewith.

AND WE HEREBY further covenant and agree that we will communicate to the said ASSIGNEE, its successors, legal representatives and assigns, any facts known to us respecting said invention, and testifying in any legal proceeding, sign all lawful papers, execute all divisional, continuing, reissue and foreign applications, make all rightful oaths, and generally do everything possible to aid the said ASSIGNEE, its successors, legal representatives and assigns, to obtain and enforce proper protection for said invention in all countries.

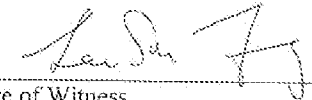
IN TESTIMONY WHEREOF, We hereunto set our hands and seals the day and year set opposite our respective signatures.

Date 22 Oct, 2013


YU Chai Mei Jimmy L.S.

Witness:

Lee Sin Fung
Printed Name of Witness

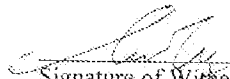

Signature of Witness

Date 22 Oct, 2013


WANG Feng L.S.

Witness:

Au Tong
Printed Name of Witness


Signature of Witness